MOSFETs Silicon N-channel MOS (U-MOSⅧ-H)

# XPN1300ANC

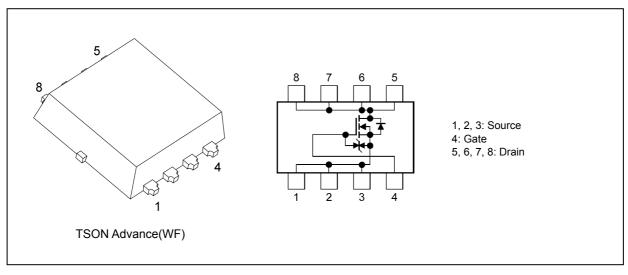
#### 1. Applications

- Automotive
- Motor Drivers
- Switching Voltage Regulators

### 2. Features

- (1) AEC-Q101 qualified
- (2) Small, thin package
- (3) Low drain-source on-resistance:  $R_{DS(ON)}$  = 11.2 mO (typ.) (V\_{GS} = 10 V)
- (4) Low leakage current:  $I_{\rm DSS}$  = 10  $\mu A$  (max) (V\_{\rm DS} = 100 V)
- (5) Enhancement mode:  $V_{th}$  = 1.5 to 2.5 V ( $V_{DS}$  = 10 V,  $I_D$  = 0.3 mA)

### 3. Packaging and Internal Circuit



#### 4. Absolute Maximum Ratings (Note) ( $T_a = 25 \ ^{\circ}C$ unless otherwise specified)

Characteris	Symbol	Rating	Unit		
Drain-source voltage			V <sub>DSS</sub>	100	V
Gate-source voltage			V <sub>GSS</sub>	±20	
Drain current (DC)		(Note 1)	Ι <sub>D</sub>	30	Α
Drain current (pulsed)		(Note 1)	I <sub>DP</sub>	60	]
Power dissipation	(T <sub>c</sub> = 25 °C)		PD	100	W
Power dissipation	(t = 10 s)	(Note 2)		2.27	1
Power dissipation	(t = 10 s)	(Note 3)		0.84	1
Single-pulse avalanche energy		(Note 4)	E <sub>AS</sub>	53	mJ
Single-pulse avalanche current			I <sub>AS</sub>	30	Α
Channel temperature		(Note 5)	T <sub>ch</sub>	175	°C
Storage temperature		(Note 5)	T <sub>stg</sub>	-55 to 175	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 5. Thermal Characteristics

Characteris	Symbol	Max	Unit		
Channel-to-case thermal impedance	(T <sub>c</sub> = 25 °C)		Z <sub>th(ch-c)</sub>	1.5	°C/W
Channel-to-ambient thermal impedance (t = 10 s) (Note 2)		Z <sub>th(ch-a)</sub>	66		
Channel-to-ambient thermal impedance	(t = 10 s)	(Note 3)	Z <sub>th(ch-a)</sub>	178	

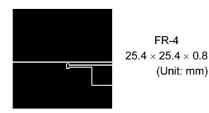
Note 1: Ensure that the channel temperature does not exceed 175 °C.

Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4:  $V_{DD}$  = 80 V,  $T_{ch}$  = 25 °C (initial), L = 45  $\mu$ H, R<sub>G</sub> = 25  $\Omega$ , I<sub>AS</sub> = 30 A

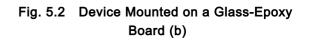
Note 5: The definitions of the absolute maximum channel and storage temperatures are qualified per AEC-Q101.





 $\begin{array}{c} \mbox{FR-4}\\ 25.4\times25.4\times0.8\\ \mbox{(Unit: mm)} \end{array}$ 

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)



Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

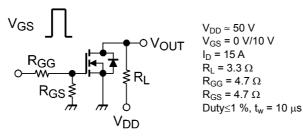
## 6. Electrical Characteristics

## 6.1. Static Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±16 V, $V_{DS}$ = 0 V	_	_	±10	μA
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V	_	_	10	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	100	_	_	V
	V <sub>(BR)DSX</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = -20 V	80	_	_	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.3 mA	1.5		2.5	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A	_	14.9	24.2	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		11.2	13.3	

## 6.2. Dynamic Characteristics (T<sub>a</sub> = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	1470	_	pF
Reverse transfer capacitance	C <sub>rss</sub>			93	—	
Output capacitance	C <sub>oss</sub>			600	—	
Gate resistance	r <sub>g</sub>			2.0	4.0	Ω
Switching time (rise time)	tr	See Fig. 6.2.1		8	_	ns
Switching time (turn-on time)	t <sub>on</sub>	1		18.6	_	
Switching time (fall time)	t <sub>f</sub>	]		9.6	_	
Switching time (turn-off time)	t <sub>off</sub>	]		38	_	



#### Fig. 6.2.1 Switching Time Test Circuit

#### 6.3. Gate Charge Characteristics ( $T_a = 25$ °C unless otherwise specified)

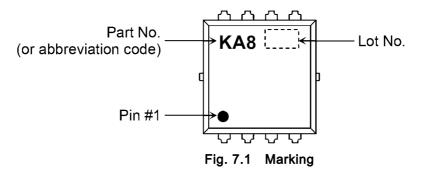
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 80$ V, $V_{GS}$ = 10 V, $I_D$ = 30 A		28	—	nC
Gate-source charge 1	Q <sub>gs1</sub>		_	7	_	
Gate-drain charge	Q <sub>gd</sub>		_	5	_	

#### 6.4. Source-Drain Characteristics ( $T_a = 25$ °C unless otherwise specified)

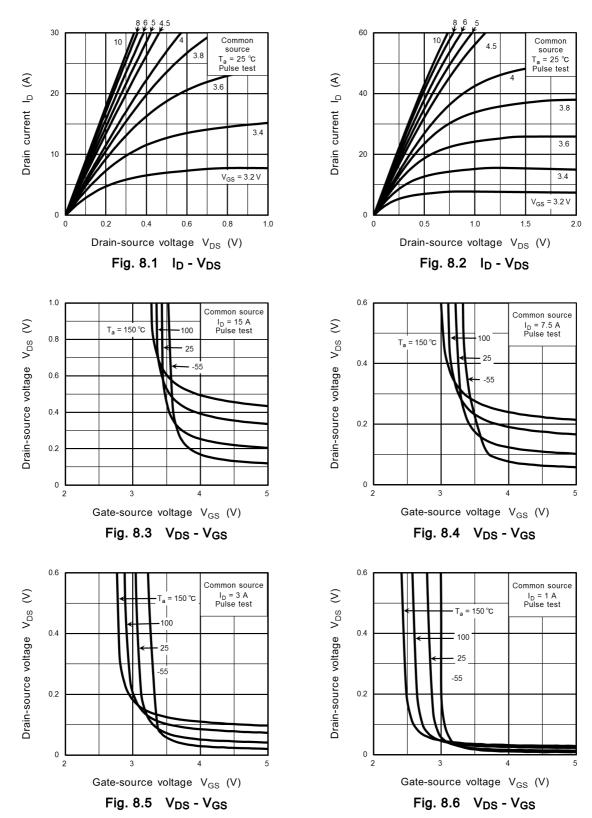
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 6)	I <sub>DRP</sub>	—	_	—	60	А
Diode forward voltage		V <sub>DSF</sub>	I <sub>DR</sub> = 30 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V

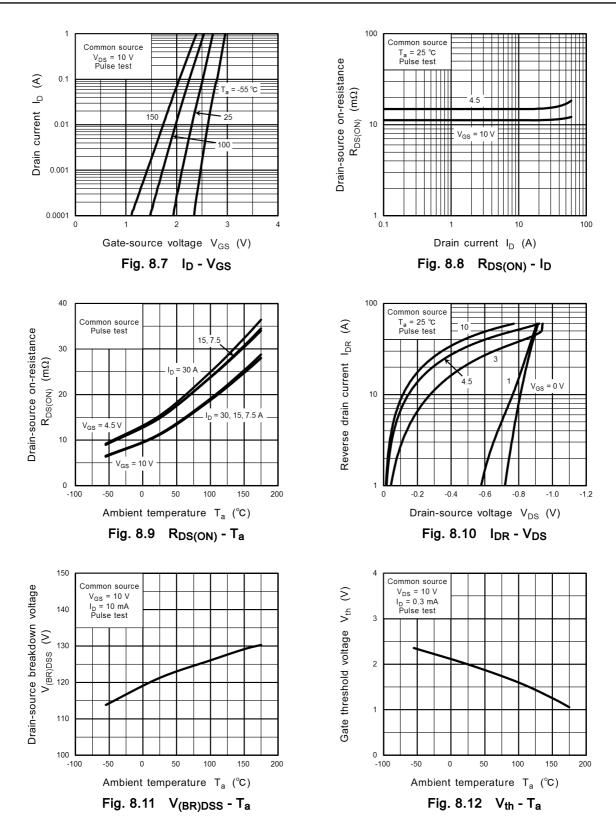
Note 6: Ensure that the channel temperature does not exceed 175 °C.

### 7. Marking



#### 8. Characteristics Curves (Note)





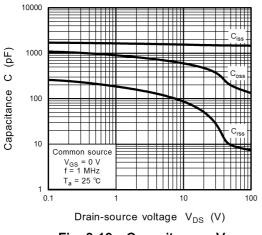
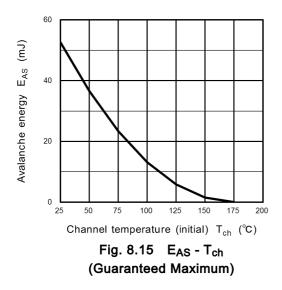


Fig. 8.13 Capacitance - V<sub>DS</sub>



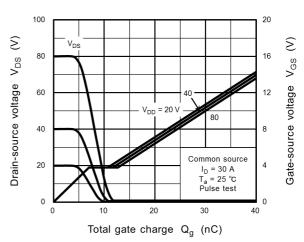


Fig. 8.14 Dynamic Input/Output Characteristics

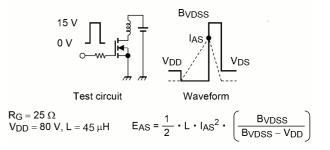
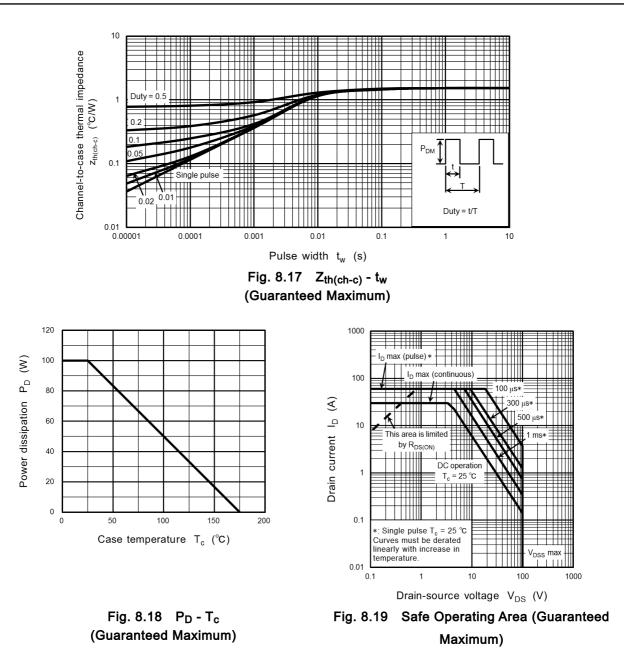


Fig. 8.16 Test Circuit/Waveform

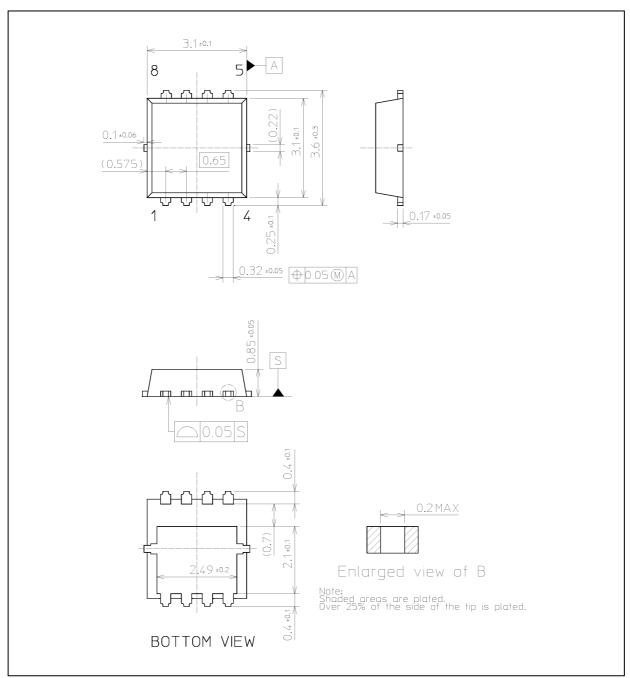


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## XPN1300ANC

#### **Package Dimensions**

Unit: mm



Weight: 0.029 g (typ.)

Package Name(s)

TOSHIBA: 2-3X2A

Nickname: TSON Advance(WF)

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